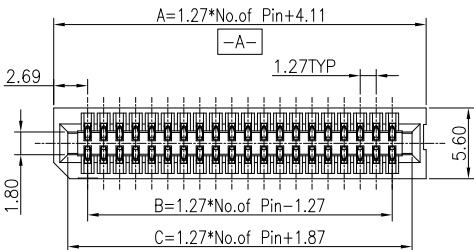
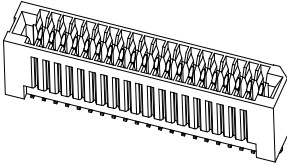
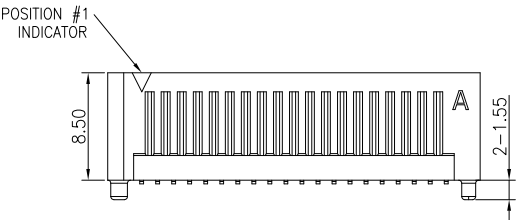
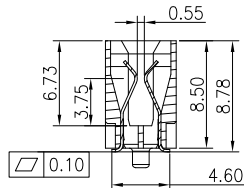
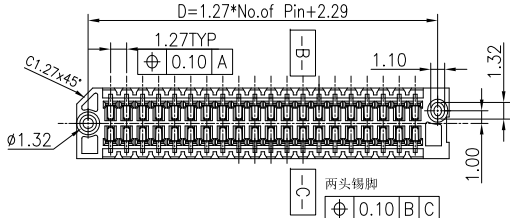
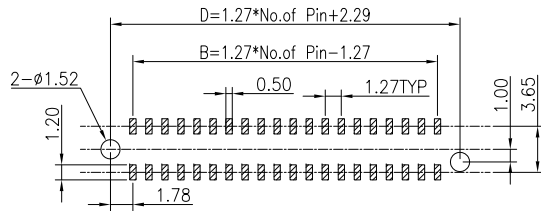
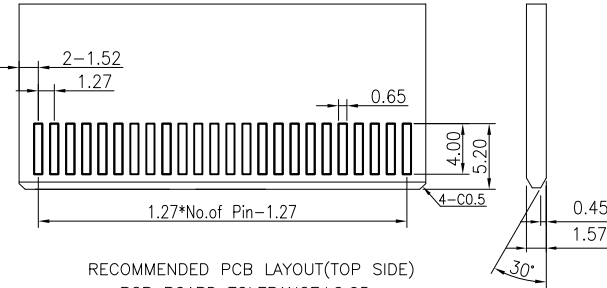


[illegible][illegible][illegible][illegible]

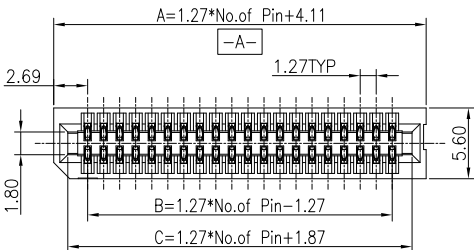
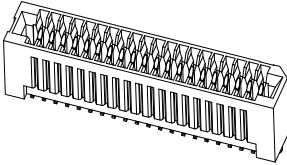
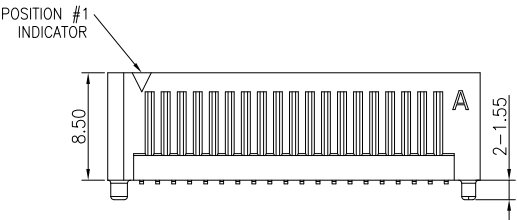
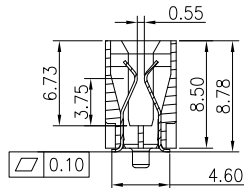
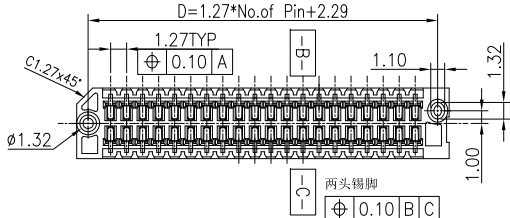
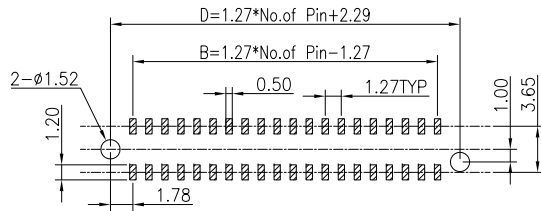
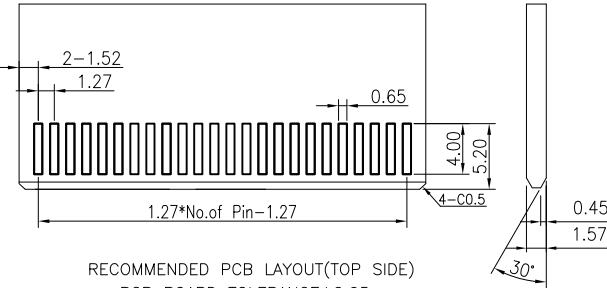
	1	2	3	4	5	6	7	8	9	10																																																																																										
A	客户图																																																																																																			
B	NOTES: 1.FINISH: 1.1 HOUSING: LCP BLACK 94V-0 1.2 CONTACT: H-HIGH CONDUCTIVE BRASS, GOLD (SEE P/N) PLATED IN CONTACT AERA, GOLD FLASH PLATED IN SOLDER AREA, 50u”MIN NICKEL UNDERPLATED OVERALL. 2. ELECTRICAL: 2.1 CURRENT RATING: 3.5A AC. DC 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 800V,AC/Minute 2.3 CONTACT RESISTANCE:20mΩ MAX. 2.4 INSULATION RESISTANCE: 1000 mΩ Min 2.5 Operation Temperature:-55°C to +125°C 3.SALT SPRAY TEST: 3.1 CONCENTRATION IS 5%, THE TEMPERATUREIS 35±2°C, TEST TIME 24H MIN,NO OXIDATION OR RUST 4.Max Processing Temp:265°C Seconds 40S 5.ORDER INFORMATION: 61F6-F XXX XX 085 C -01 PIN数: 端子电镀: 塑胶高度: 004=2x2PIN G0=Gold Flash(全金) 085=8.50mm G1=1u” Gold 050=2x25PIN G2=3u” Gold G3=5u” Gold G4=10u” Gold G5=15u” Gold G6=30u” Gold																																																																																																			
C	 																																																																																																			
D	 																																																																																																			
E																																																																																																				
F	 																																																																																																			
G	RECOMMENDED PCB LAYOUT(TOP SIDE) PCB BOARD TOLERANCE±0.05																																																																																																			
H	<table border="1"> <thead> <tr> <th>REV</th><th>DATE</th><th>MODIFICATION DESCRIPTION</th><th>CHANGE</th><th>APPROVE</th><th>OPERATION</th><th>DRAW</th><th>WLY</th><th>SCALE</th><th>SHEET</th><th>PROJ.</th><th>SIZE</th><th>PART NO.</th><th>TITLE:</th><th>DRAW NO.</th></tr> </thead> <tbody> <tr> <td>A0</td><td></td><td>NEW</td><td></td><td></td><td>X.X ±0.40</td><td>DESIGN</td><td>Jensen</td><td>2021.02.03</td><td>1/1</td><td></td><td>A4</td><td>61F6-FXXX-XX-085-C01</td><td>1.27mm 金手指 SMT 180° 焊脚4.60mm</td><td>SP-1862</td></tr> <tr> <td></td><td></td><td></td><td></td><td></td><td>X.XX ±0.25</td><td>CHECK</td><td>Jack</td><td>2021.02.03</td><td></td><td></td><td></td><td></td><td></td><td></td></tr> <tr> <td></td><td></td><td></td><td></td><td></td><td>X.XXX ±0.15</td><td>APPROVE</td><td>Andy</td><td>2021.02.03</td><td></td><td></td><td></td><td></td><td></td><td></td></tr> <tr> <td></td><td></td><td></td><td></td><td></td><td>Angle ±3°</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></tr> <tr> <td></td><td></td><td></td><td></td><td></td><td>DIM. TOL</td><td>UNIT</td><td>mm</td><td>SCALE</td><td>1:1</td><td></td><td></td><td></td><td></td><td></td></tr> </tbody> </table>										REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WLY	SCALE	SHEET	PROJ.	SIZE	PART NO.	TITLE:	DRAW NO.	A0		NEW			X.X ±0.40	DESIGN	Jensen	2021.02.03	1/1		A4	61F6-FXXX-XX-085-C01	1.27mm 金手指 SMT 180° 焊脚4.60mm	SP-1862						X.XX ±0.25	CHECK	Jack	2021.02.03												X.XXX ±0.15	APPROVE	Andy	2021.02.03												Angle ±3°															DIM. TOL	UNIT	mm	SCALE	1:1					
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WLY	SCALE	SHEET	PROJ.	SIZE	PART NO.	TITLE:	DRAW NO.																																																																																						
A0		NEW			X.X ±0.40	DESIGN	Jensen	2021.02.03	1/1		A4	61F6-FXXX-XX-085-C01	1.27mm 金手指 SMT 180° 焊脚4.60mm	SP-1862																																																																																						
					X.XX ±0.25	CHECK	Jack	2021.02.03																																																																																												
					X.XXX ±0.15	APPROVE	Andy	2021.02.03																																																																																												
					Angle ±3°																																																																																															
					DIM. TOL	UNIT	mm	SCALE	1:1																																																																																											
	1	2	3	4	5	6	7	8	9	10																																																																																										

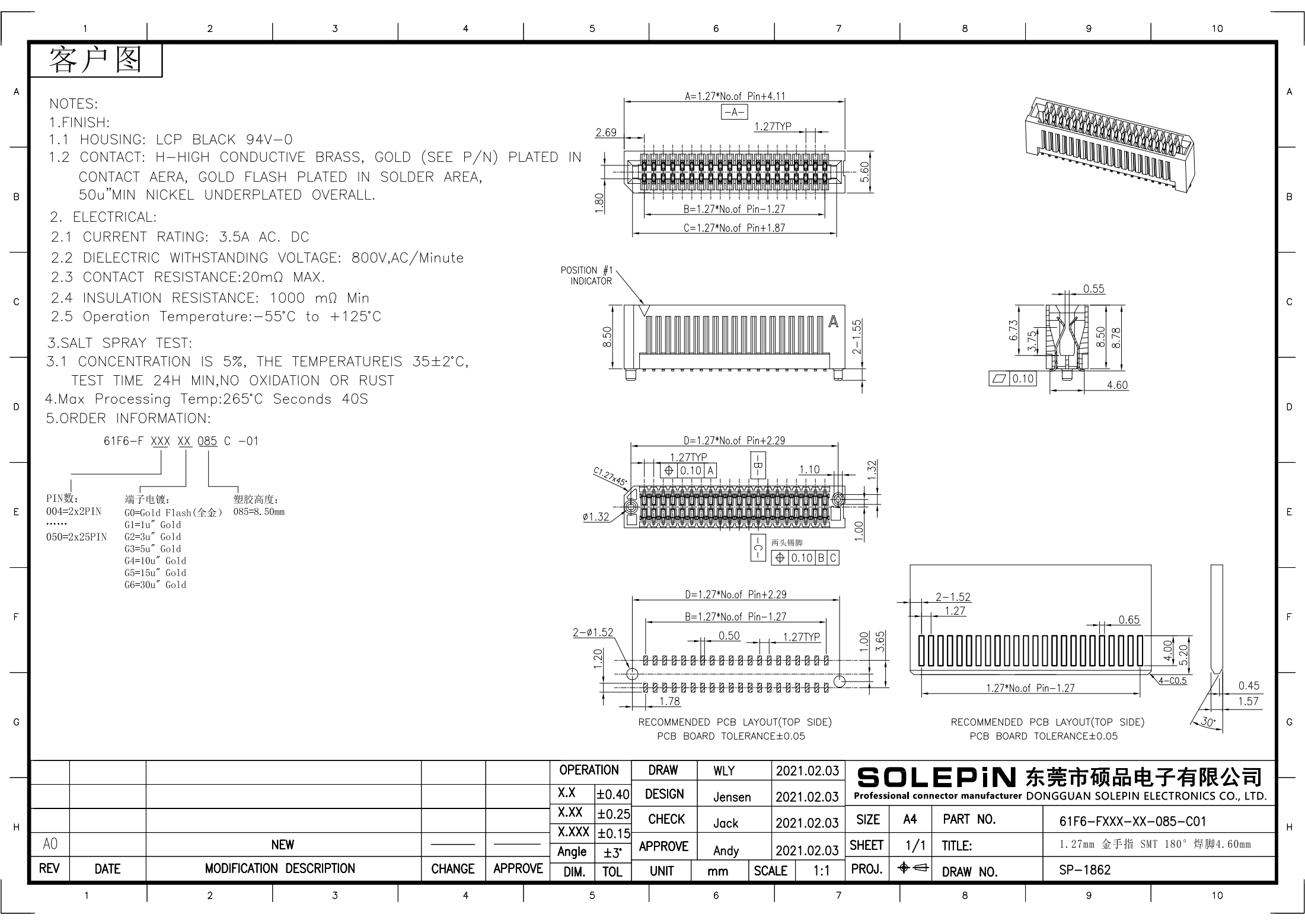
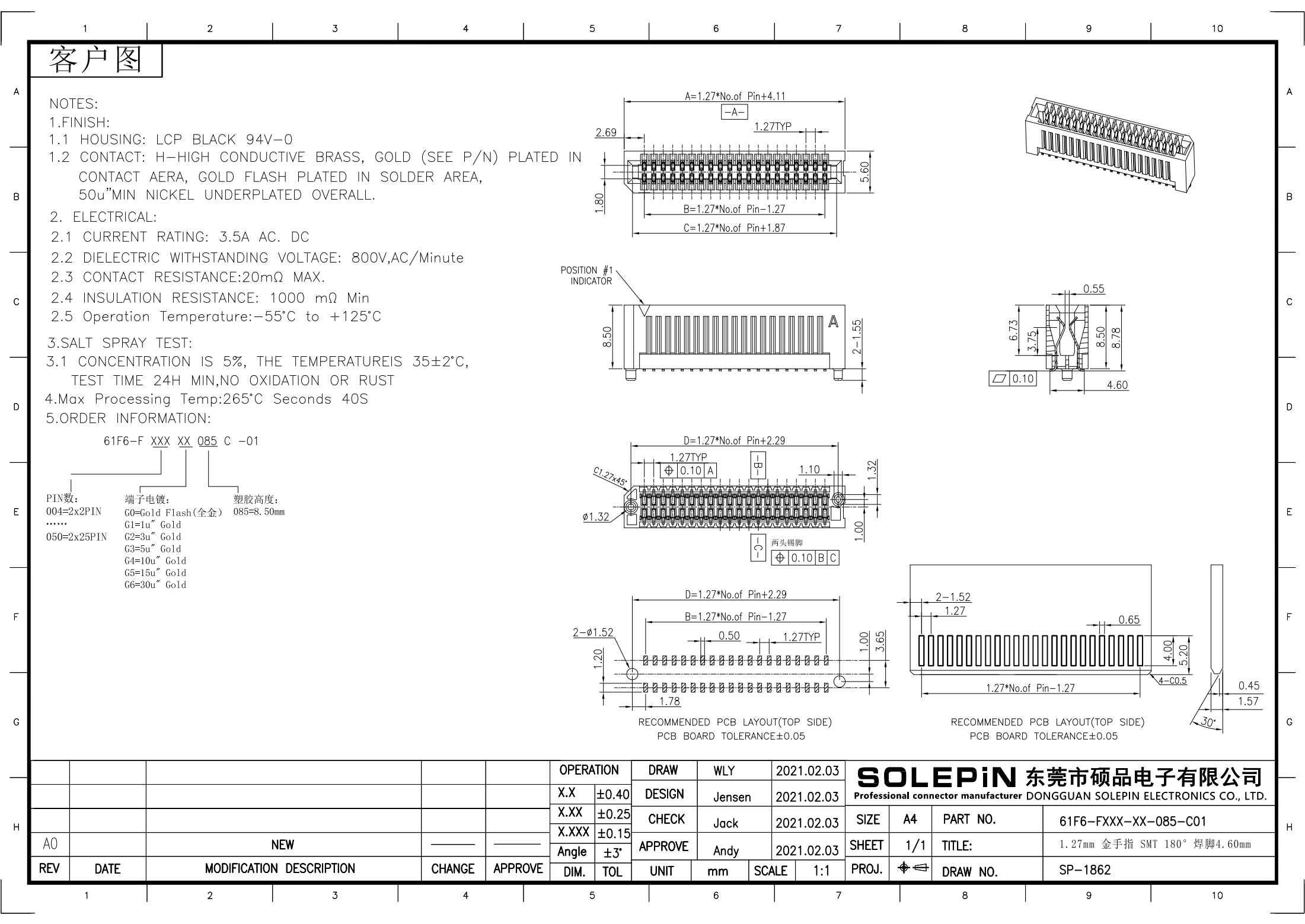
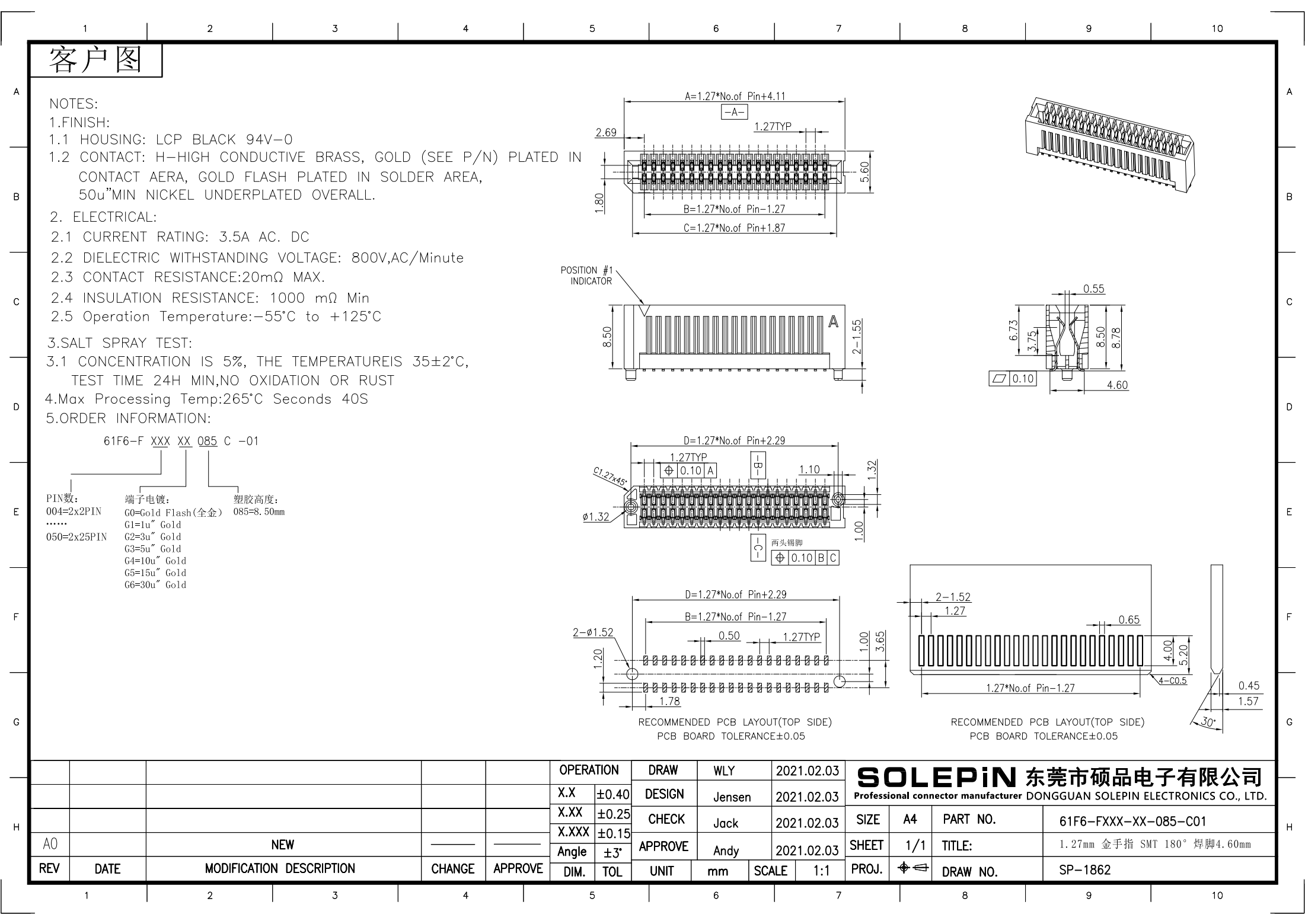
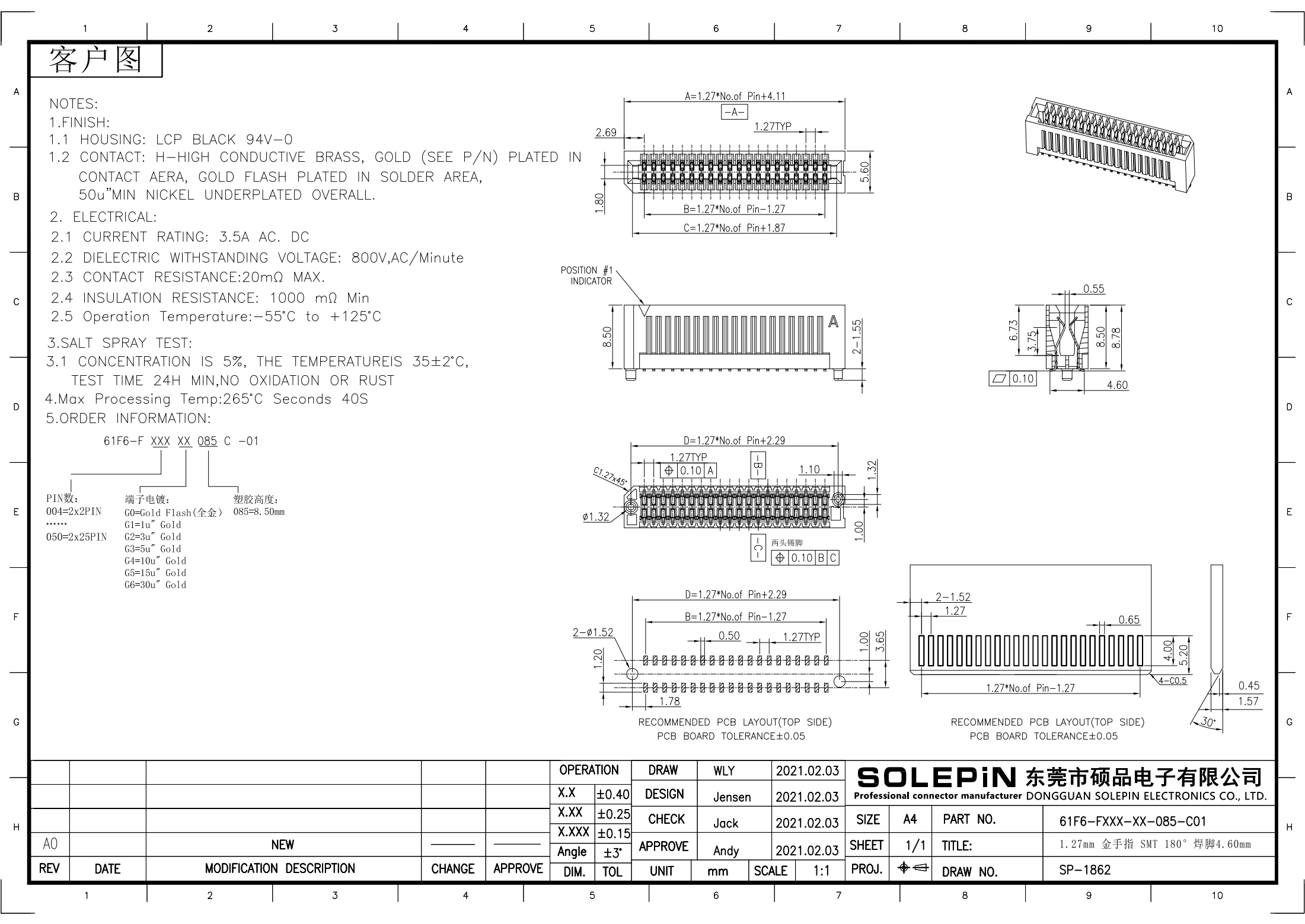
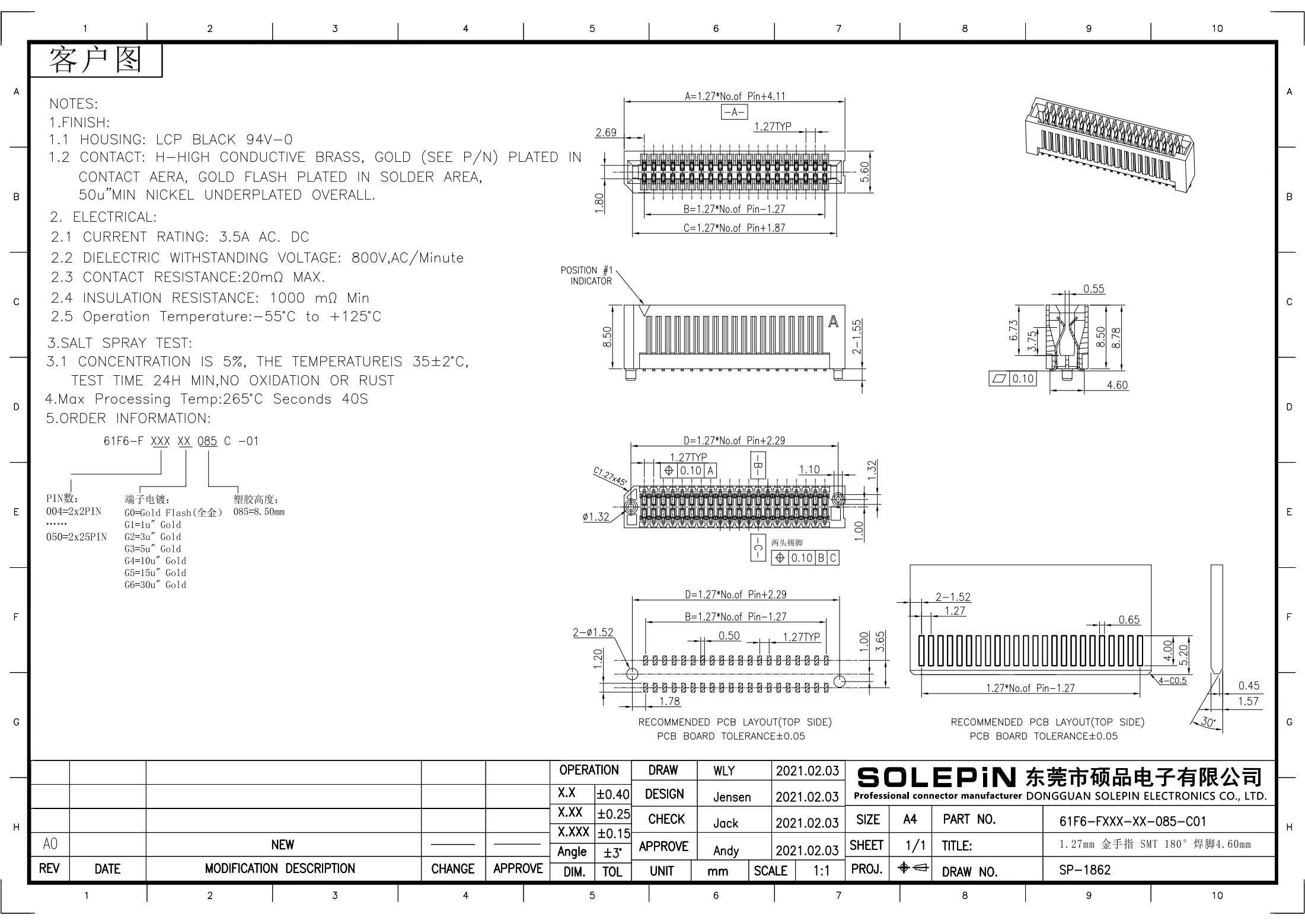
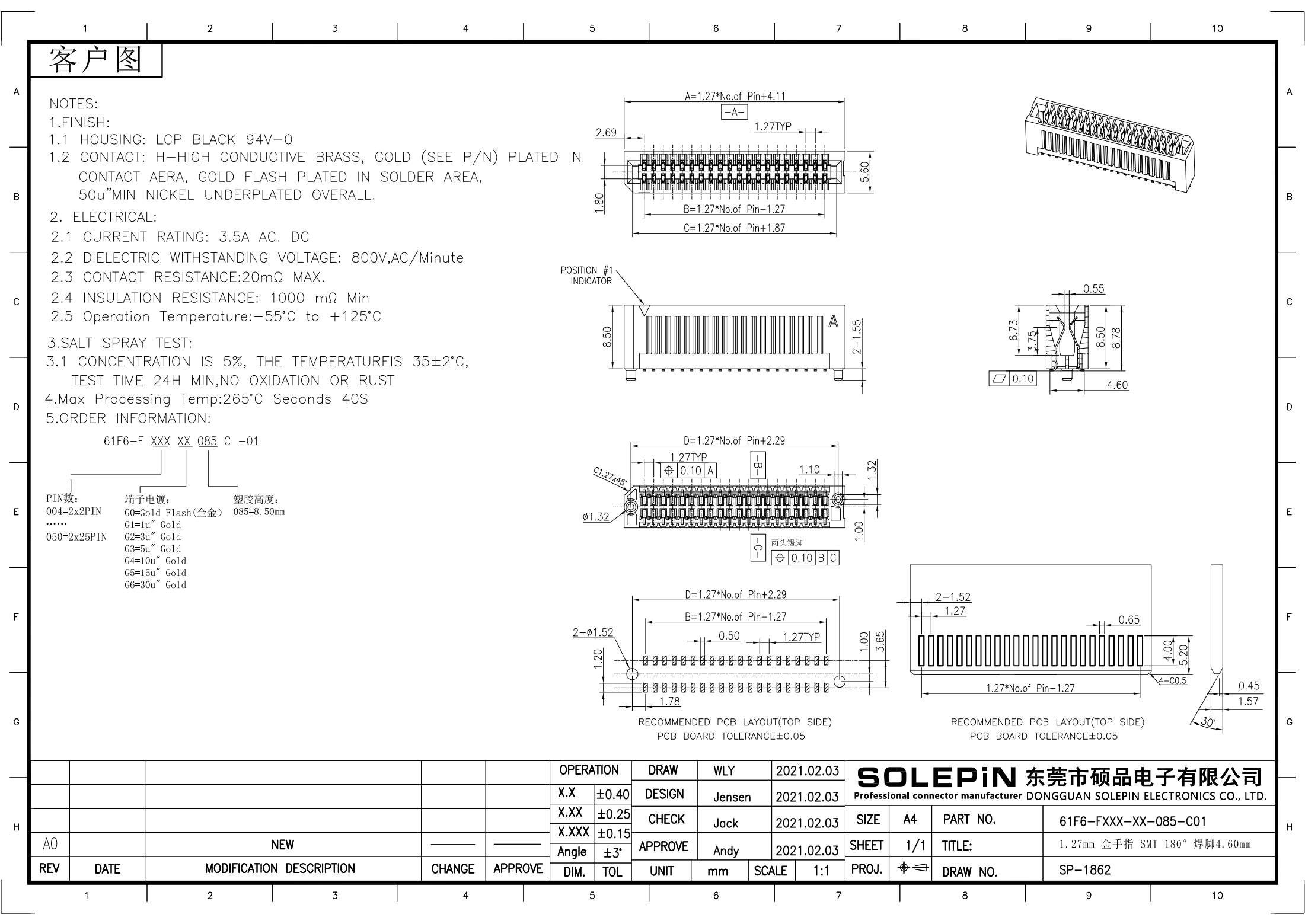
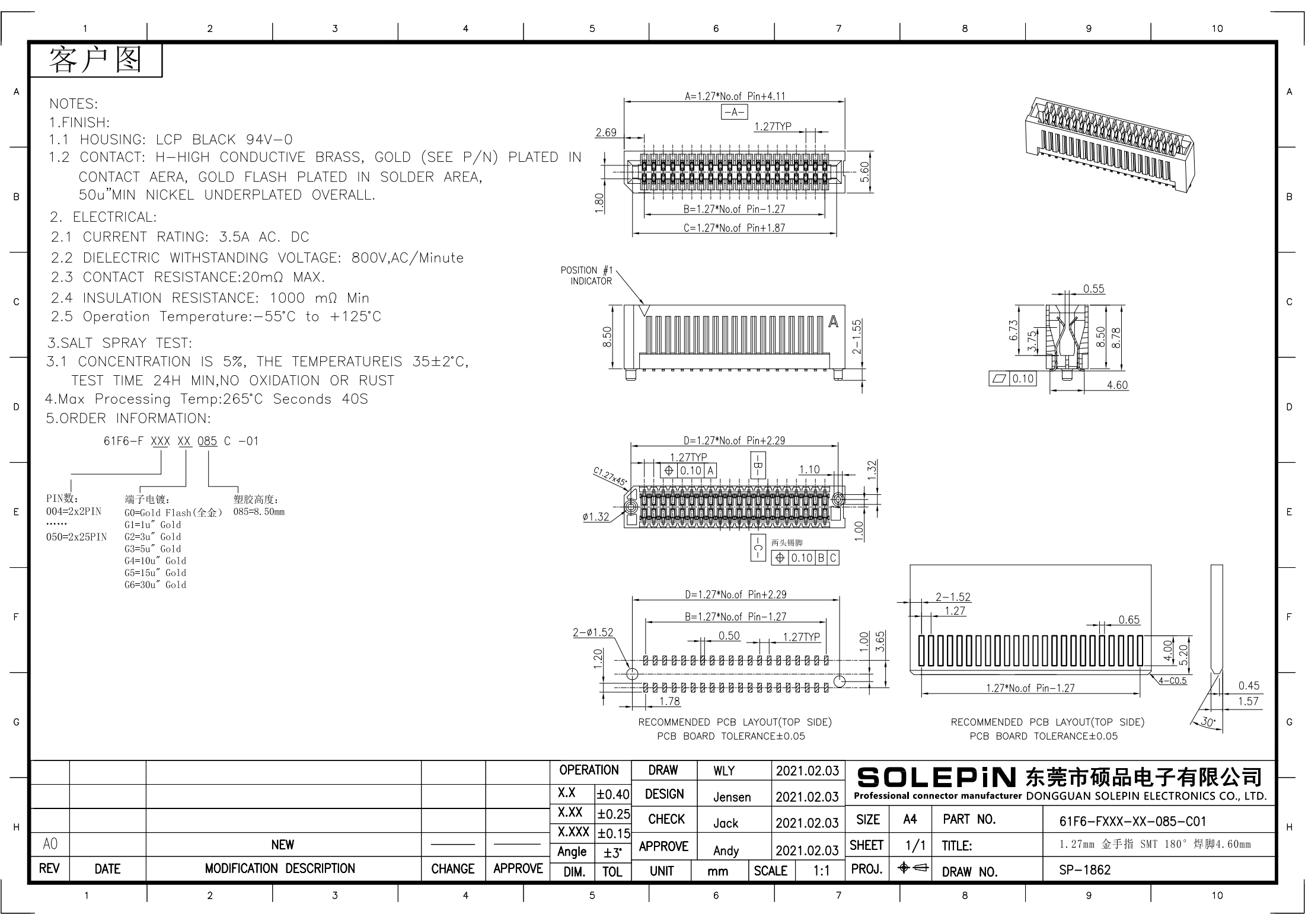
[illegible][illegible][illegible][illegible][illegible][illegible][illegible][illegible]

	1	2	3	4	5	6	7	8	9	10
A	客户图									
B	NOTES: 1.FINISH: 1.1 HOUSING: LCP BLACK 94V-0 1.2 CONTACT: H-HIGH CONDUCTIVE BRASS, GOLD (SEE P/N) PLATED IN CONTACT AREA, GOLD FLASH PLATED IN SOLDER AREA, 50μ"MIN NICKEL UNDERPLATED OVERALL. 2. ELECTRICAL: 2.1 CURRENT RATING: 3.5A AC. DC 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 800V,AC/Minute 2.3 CONTACT RESISTANCE:20mΩ MAX. 2.4 INSULATION RESISTANCE: 1000 mΩ Min 2.5 Operation Temperature:-55°C to +125°C 3.SALT SPRAY TEST: 3.1 CONCENTRATION IS 5%, THE TEMPERATUREIS 35±2°C, TEST TIME 24H MIN,NO OXIDATION OR RUST 4.Max Processing Temp:265°C Seconds 40S 5.ORDER INFORMATION: 61F6-F XXX XX 085 C -01 PIN数: 004=2x2PIN 050=2x25PIN 端子电镀: G0=Gold Flash(全金) G1=1u" Gold G2=3u" Gold G3=5u" Gold G4=10u" Gold G5=15u" Gold G6=30u" Gold 塑胶高度: 085=8.50mm					A=1.27*No.of Pin+4.11 -A- 2.69 1.80 1.27TYP 5.60 B=1.27*No.of Pin-1.27 C=1.27*No.of Pin+1.87 POSITION #1 INDICATOR 8.50 2-1.55 D=1.27*No.of Pin+2.29 1.27TYP Φ 0.10 A 1.10 1.32 1.00 1.27 Φ 0.10 B/C 两头锡脚 2-Ø1.52 1.20 1.78 0.50 1.27TYP 1.00 3.65 D=1.27*No.of Pin+2.29 B=1.27*No.of Pin-1.27 2-1.52 1.27 0.65 4.00 5.20 1.27*No.of Pin-1.27 4-C0.5 0.45 1.57 30° RECOMMENDED PCB LAYOUT(TOP SIDE) PCB BOARD TOLERANCE±0.05 RECOMMENDED PCB LAYOUT(TOP SIDE) PCB BOARD TOLERANCE±0.05				
C										
D										
E										
F										
G										
H										
I										
J										
K										
L										
M										
N										
O										
P										
Q										
R										
S										
T										
U										
V										
W										
X										
Y										
Z										

[illegible]

	1	2	3	4	5	6	7	8	9	10																																																																
A	客户图																																																																									
B	NOTES: 1.FINISH: 1.1 HOUSING: LCP BLACK 94V-0 1.2 CONTACT: H-HIGH CONDUCTIVE BRASS, GOLD (SEE P/N) PLATED IN CONTACT AERA, GOLD FLASH PLATED IN SOLDER AREA, 50u”MIN NICKEL UNDERPLATED OVERALL. 2. ELECTRICAL: 2.1 CURRENT RATING: 3.5A AC. DC 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 800V,AC/Minute 2.3 CONTACT RESISTANCE:20mΩ MAX. 2.4 INSULATION RESISTANCE: 1000 mΩ Min 2.5 Operation Temperature:-55℃ to +125℃ 3.SALT SPRAY TEST: 3.1 CONCENTRATION IS 5%, THE TEMPERATUREIS 35±2℃, TEST TIME 24H MIN,NO OXIDATION OR RUST 4.Max Processing Temp:265℃ Seconds 40S 5.ORDER INFORMATION: 61F6-F XXX XX 085 C -01 PIN数: 004=2x2PIN 050=2x25PIN 端子电镀: G0=Gold Flash(全金) G1=1u” Gold G2=3u” Gold G3=5u” Gold G4=10u” Gold G5=15u” Gold G6=30u” Gold 塑胶高度: 085=8.5mm																																																																									
C																																																																										
D																																																																										
E																																																																										
F																																																																										
G																																																																										
H	<table border="1"><thead><tr><th colspan="2"></th><th colspan="2">OPERATION</th><th colspan="2">DRAW</th><th colspan="2">WLY</th><th colspan="2">2021.02.03</th><th colspan="2">SOLEPiN 东莞市硕品电子有限公司</th></tr></thead><tbody><tr><td colspan="2"></td><td>X.X</td><td>±0.40</td><td colspan="2">DESIGN</td><td>Jensen</td><td colspan="2">2021.02.03</td><td colspan="3">Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.</td></tr><tr><td colspan="2"></td><td>X.XX</td><td>±0.25</td><td colspan="2">CHECK</td><td>Jack</td><td colspan="2">2021.02.03</td><td colspan="3">SIZE A4 PART NO. 61F6-FXXX-XX-085-C01</td></tr><tr><td colspan="2"></td><td>X.XXX</td><td>±0.15</td><td colspan="2">APPROVE</td><td>Andy</td><td colspan="2">2021.02.03</td><td>SHEET 1/1 TITLE: 1.27mm 金手指 SMT 180° 焊脚4.60mm</td><td colspan="2"></td></tr><tr><td>REV</td><td>DATE</td><td colspan="2">MODIFICATION DESCRIPTION</td><td>CHANGE</td><td>APPROVE</td><td>DIM.</td><td>TOL</td><td>UNIT</td><td>mm</td><td>SCALE</td><td>1:1</td><td>PROJ.</td><td>⇄</td><td>DRAW NO.</td><td>SP-1862</td></tr></tbody></table>												OPERATION		DRAW		WLY		2021.02.03		SOLEPiN 东莞市硕品电子有限公司				X.X	±0.40	DESIGN		Jensen	2021.02.03		Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.					X.XX	±0.25	CHECK		Jack	2021.02.03		SIZE A4 PART NO. 61F6-FXXX-XX-085-C01					X.XXX	±0.15	APPROVE		Andy	2021.02.03		SHEET 1/1 TITLE: 1.27mm 金手指 SMT 180° 焊脚4.60mm			REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.	⇄	DRAW NO.	SP-1862
		OPERATION		DRAW		WLY		2021.02.03		SOLEPiN 东莞市硕品电子有限公司																																																																
		X.X	±0.40	DESIGN		Jensen	2021.02.03		Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.																																																																	
		X.XX	±0.25	CHECK		Jack	2021.02.03		SIZE A4 PART NO. 61F6-FXXX-XX-085-C01																																																																	
		X.XXX	±0.15	APPROVE		Andy	2021.02.03		SHEET 1/1 TITLE: 1.27mm 金手指 SMT 180° 焊脚4.60mm																																																																	
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.	⇄	DRAW NO.	SP-1862																																																											
I	1	2	3	4	5	6	7	8	9	10																																																																

	1	2	3	4	5	6	7	8	9	10																																																																																						
A	客户图																																																																																															
B	NOTES: 1.FINISH: 1.1 HOUSING: LCP BLACK 94V-0 1.2 CONTACT: H-HIGH CONDUCTIVE BRASS, GOLD (SEE P/N) PLATED IN CONTACT AERA, GOLD FLASH PLATED IN SOLDER AREA, 50u”MIN NICKEL UNDERPLATED OVERALL. 2. ELECTRICAL: 2.1 CURRENT RATING: 3.5A AC. DC 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 800V,AC/Minute 2.3 CONTACT RESISTANCE:20mΩ MAX. 2.4 INSULATION RESISTANCE: 1000 mΩ Min 2.5 Operation Temperature:-55°C to +125°C 3.SALT SPRAY TEST: 3.1 CONCENTRATION IS 5%, THE TEMPERATUREIS 35±2°C, TEST TIME 24H MIN,NO OXIDATION OR RUST 4.Max Processing Temp:265°C Seconds 40S 5.ORDER INFORMATION: 61F6-F XXX XX 085 C -01 PIN数: 端子电镀: 塑胶高度: 004=2x2PIN G0=Gold Flash(全金) 085=8.50mm G1=1u” Gold 050=2x25PIN G2=3u” Gold G3=5u” Gold G4=10u” Gold G5=15u” Gold G6=30u” Gold																																																																																															
C	 																																																																																															
D	 																																																																																															
E																																																																																																
F	 																																																																																															
G	RECOMMENDED PCB LAYOUT(TOP SIDE) PCB BOARD TOLERANCE±0.05																																																																																															
H	<table border="1"> <thead> <tr> <th>REV</th><th>DATE</th><th>MODIFICATION DESCRIPTION</th><th>CHANGE</th><th>APPROVE</th><th>DIM.</th><th>TOL</th><th>UNIT</th><th>mm</th><th>SCALE</th><th>1:1</th><th>PROJ.</th><th>SHEET</th><th>1/1</th><th>TITLE:</th><th>SP-1862</th></tr> </thead> <tbody> <tr> <td>A0</td><td></td><td>NEW</td><td></td><td></td><td>X.XXX</td><td>±0.15</td><td>Angle</td><td>±3°</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></tr> </tbody> </table>																REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.	SHEET	1/1	TITLE:	SP-1862	A0		NEW			X.XXX	±0.15	Angle	±3°																																																							
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.	SHEET	1/1	TITLE:	SP-1862																																																																																	
A0		NEW			X.XXX	±0.15	Angle	±3°																																																																																								
	<table border="1"> <thead> <tr> <th>OPERATION</th><th>DRAW</th><th>WLY</th><th>2021.02.03</th><th colspan="12">SOLEPiN 东莞市硕品电子有限公司</th></tr> <tr> <th>DESIGN</th><th>Jensen</th><th>2021.02.03</th><th colspan="13">Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.</th></tr> </thead> <tbody> <tr> <td>X.X ±0.40</td><td>CHECK</td><td>Jack</td><td>2021.02.03</td><td>SIZE</td><td>A4</td><td>PART NO.</td><td colspan="9">61F6-FXXX-XX-085-C01</td></tr> <tr> <td>X.XXX ±0.15</td><td>APPROVE</td><td>Andy</td><td>2021.02.03</td><td>SHEET</td><td>1/1</td><td>TITLE:</td><td colspan="9">1.27mm 金手指 SMT 180° 焊脚4.60mm</td></tr> <tr> <td>Angle ±3°</td><td></td><td></td><td></td><td>PROJ.</td><td>⇄</td><td>DRAW NO.</td><td colspan="9">SP-1862</td></tr> </tbody> </table>																OPERATION	DRAW	WLY	2021.02.03	SOLEPiN 东莞市硕品电子有限公司												DESIGN	Jensen	2021.02.03	Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.													X.X ±0.40	CHECK	Jack	2021.02.03	SIZE	A4	PART NO.	61F6-FXXX-XX-085-C01									X.XXX ±0.15	APPROVE	Andy	2021.02.03	SHEET	1/1	TITLE:	1.27mm 金手指 SMT 180° 焊脚4.60mm									Angle ±3°				PROJ.	⇄	DRAW NO.	SP-1862								
OPERATION	DRAW	WLY	2021.02.03	SOLEPiN 东莞市硕品电子有限公司																																																																																												
DESIGN	Jensen	2021.02.03	Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.																																																																																													
X.X ±0.40	CHECK	Jack	2021.02.03	SIZE	A4	PART NO.	61F6-FXXX-XX-085-C01																																																																																									
X.XXX ±0.15	APPROVE	Andy	2021.02.03	SHEET	1/1	TITLE:	1.27mm 金手指 SMT 180° 焊脚4.60mm																																																																																									
Angle ±3°				PROJ.	⇄	DRAW NO.	SP-1862																																																																																									
	1	2	3	4	5	6	7	8	9	10																																																																																						



客户图

NOTES:

1.FINISH:

1.1 HOUSING: LCP BLACK 94V-0
1.2 CONTACT: H-HIGH CONDUCTIVE BRASS, GOLD (SEE P/N) PLATED IN CONTACT AERA, GOLD FLASH PLATED IN SOLDER AREA, 50u”MIN NICKEL UNDERPLATED OVERALL.

2. ELECTRICAL:

2.1 CURRENT RATING: 3.5A AC. DC
2.2 DIELECTRIC WITHSTANDING VOLTAGE: 800V,AC/Minute
2.3 CONTACT RESISTANCE:20mΩ MAX.
2.4 INSULATION RESISTANCE: 1000 mΩ Min
2.5 Operation Temperature:-55°C to +125°C

3.SALT SPRAY TEST:

3.1 CONCENTRATION IS 5%, THE TEMPERATUREIS 35±2°C,
TEST TIME 24H MIN,NO OXIDATION OR RUST

4.Max Processing Temp:265°C Seconds 40S

5.ORDER INFORMATION:

61F6-F XXX XX 085 C -01

PIN数:
004=2x2PIN
.....
050=2x25PIN

端子电镀:
G0=Gold Flash(全金)
G1=1u” Gold
G2=3u” Gold
G3=5u” Gold
G4=10u” Gold
G5=15u” Gold
G6=30u” Gold

塑胶高度:
085=8.50mm

A=1.27*No.of Pin+4.11
B=1.27*No.of Pin-1.27
C=1.27*No.of Pin+1.87

POSITION #1 INDICATOR

0.55
6.73
3.75
8.50
8.78
0.10
4.60

D=1.27*No.of Pin+2.29
1.27TYP
1.10
1.32
1.00
0.10 B/C

D=1.27*No.of Pin+2.29
B=1.27*No.of Pin-1.27
1.27TYP
0.50
1.27
1.00
3.65
1.20
1.78
2-φ1.52

RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLERANCE±0.05

2-1.52
1.27
0.65
4.00
5.20
1.27*No.of Pin-1.27
4-C0.5
0.45
1.57
30°

RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLERANCE±0.05

						OPERATION	DRAW	WLY	2021.02.03	SOLEPiN 东莞市硕品电子有限公司					
						X.X ±0.40	DESIGN	Jensen	2021.02.03	Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.					
						X.XX ±0.25	CHECK	Jack	2021.02.03	SIZE	A4	PART NO.	61F6-FXXX-XX-085-C01		
						X.XXX ±0.15	APPROVE	Andy	2021.02.03	SHEET	1/1	TITLE:	1.27mm 金手指 SMT 180° 焊脚4.60mm		
REV	DATE	MODIFICATION DESCRIPTION			CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.	DRAW NO.	SP-1862

1 2 3 4 5 6 7 8 9 10

